

DUAL-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

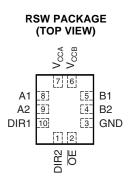
FEATURES

- Each Channel Has Independent Direction Control
- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant
- I_{off} Supports Partial-Power-Down Mode
 Operation
- Typical Data Rates
 - 500 Mbps (1.8-V to 3.3-V Translation)
 - 320 Mbps (<1.8-V to 3.3-V Translation)
 - 320 Mbps (Translate to 2.5 V or 1.8 V)
 - 280 Mbps (Translate to 1.5 V)
 - 240 Mbps (Translate to 1.2 V)

DESCRIPTION/ORDERING INFORMATION

Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II

- ESD Protection Exceeds JESD 22
 - 5000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1500-V Charged-Device Model (C101)



This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

ORDERING INFORMATION

| T _A | PACKAGE | (1)(2) | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|---------------|-----------------------|------------------|
| -40°C to 85°C | QFN – RSW | Tape and reel | SN74AVC2T245RSWR | TLO |

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The SN74AVC2T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (\overline{OE}) activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode . The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ} .

The SN74AVC2T245 is designed so that the control pins (DIR1, DIR2, and \overline{OE}) are supplied by V_{CCA}.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

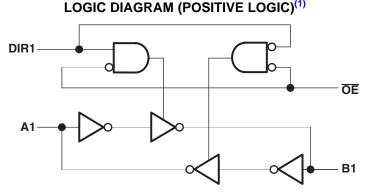
The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} must be connected to V_{CC} through a pull-up resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

| CONTRO | L INPUTS | OUTPUT | CIRCUITS | |
|--------|----------|---------|---------------|------------------|
| OE | DIR1 | A PORT | B PORT | OPERATION |
| L | L | Enabled | Hi-Z | B data to A data |
| L | Н | Hi-Z | Enabled | A data to B data |
| Н | Х | Hi-Z | Hi-Z | Isolation |

FUNCTION TABLE⁽¹⁾ (EACH TRANSCEIVER)

(1) Input circuits of the data I/Os are always active.



(1) Shown for a single channel



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TYPICAL APPLICATION

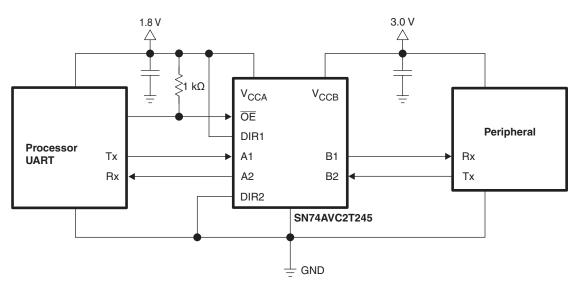


Figure 1. Typical Application of the SN74AVC2T245

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------|---|----------------------------|------|------------------------|------|
| $V_{CCA} V_{CCB}$ | Supply voltage range | | -0.5 | 4.6 | V |
| | | I/O ports (A port) | -0.5 | 4.6 | |
| VI | Input voltage range ⁽²⁾ | I/O ports (B port) | -0.5 | 4.6 | V |
| | | Control inputs | -0.5 | 4.6 | |
| V | Voltage range applied to any output in the high-impedance or | A port | -0.5 | 4.6 | V |
| Vo | power-off state ⁽²⁾ | B port | -0.5 | 4.6 | v |
| N/ | λ (alternative condition) to a set of the state of the state (2)(3) | A port | -0.5 | V _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state $^{(2)(3)}$ | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| lo | Continuous output current | 1 | | ±50 | mA |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA |
| | | D package ⁽⁴⁾ | | 73 | |
| | | DB package ⁽⁴⁾ | | 82 | |
| θ_{JA} | Package thermal impedance | DGV package ⁽⁴⁾ | | 120 | °C/W |
| | | PW package ⁽⁴⁾ | | 108 | |
| | | RGY package ⁽⁵⁾ | | 39 | |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

(5) The package thermal impedance is calculated in accordance with JESD 51-5.

SCES692-JUNE 2008

RECOMMENDED OPERATING CONDITIONS⁽¹⁾⁽²⁾⁽³⁾

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|-----------------------------|---|------------------|------------------|-----------------------|-----------------------|------|
| V _{CCA} | Supply voltage | | | | 1.2 | 3.6 | V |
| V _{CCB} | Supply voltage | | | | 1.2 | 3.6 | V |
| | | | 1.2 V to 1.95 V | | $V_{CCI} \times 0.65$ | | |
| VIH | High-level input voltage | Data inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCI} \times 0.35$ | |
| V _{IL} | Low-level input voltage | Data inputs ⁽⁴⁾ | 1.95 V to 2.7 V | | | 0.7 | V |
| | input voltage | | 2.7 V to 3.6 V | | | 0.8 | |
| | | | 1.2 V to 1.95 V | | $V_{CCA} \times 0.65$ | | |
| VIH | High-level input voltage | DIR (referenced to V _{CCA}) ⁽⁵⁾ | 1.95 V to 2.7 V | | 1.6 | | V |
| | input voltage | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.2 V to 1.95 V | | | $V_{CCA} \times 0.35$ | |
| VIL | Low-level input voltage | DIR (referenced to V _{CCA}) ⁽⁵⁾ | 1.95 V to 2.7 V | | | 0.7 | V |
| | input voltage | | 2.7 V to 3.6 V | | | 0.8 | |
| VI | Input voltage | | | | 0 | 3.6 | V |
| Vo | Output voltage | Active state | | | 0 | V _{CCO} | V |
| ۷O | Oulput voltage | 3-state | | | 0 | 3.6 | v |
| | | | | 1.1 V to 1.2 V | | -3 | |
| | | | | 1.4 V to 1.6 V | | -6 | |
| I _{OH} | High-level output c | current | | 1.65 V to 1.95 V | | -8 | mA |
| | | | | 2.3 V to 2.7 V | | -9 | |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.1 V to 1.2 V | | 3 | |
| | | | | 1.4 V to 1.6 V | | 6 | |
| l _{OL} | Low-level output co | urrent | | 1.65 V to 1.95 V | | 8 | mA |
| | | | | 2.3 V to 2.7 V | | 9 | |
| | | | | 3 V to 3.6 V | | 12 | |
| ∆t/∆v | Input transition rise | e or fall rate | | | | 5 | ns/V |
| T _A | Operating free-air | temperature | | | -40 | 85 | °C |

V_{CCI} is the V_{CC} associated with the input port.
 V_{CCO} is the V_{CC} associated with the output port.
 All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V
 For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V



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ELECTRICAL CHARACTERISTICS⁽¹⁾⁽²⁾

over recommended operating free-air temperature range (unless otherwise noted)

| | RAMETER | TEST CONDI | | V | V | Τ ₄ | ∖ = 25°C | | –40°C to 8 | 5°C | UNIT |
|--------------------|-------------------|---|-----------------------------------|------------------|------------------|----------------|----------|-------|-----------------|------|------|
| PAI | RAINETER | TEST CONDI | TIONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | MIN | MAX | UNI |
| | | I _{OH} = −100 μA | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | $V_{CCO} - 0.2$ | | |
| | | I _{OH} = -3 mA | | 1.2 V | 1.2 V | | 0.95 | | | | |
| | | I _{OH} = -6 mA | | 1.4 V | 1.4 V | | | | 1.05 | | V |
| V _{OH} | | I _{OH} =8 mA | $V_{I} = V_{IH}$ | 1.65 V | 1.65 V | | | | 1.2 | | v |
| | | I _{OH} = -9 mA | | 2.3 V | 2.3 V | | | | 1.75 | | |
| | | I _{OH} = -12 mA | | 3 V | 3 V | | | | 2.3 | | |
| | | I _{OL} = 100 μA | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 0.2 | |
| | | I _{OL} = 3 mA | | 1.2 V | 1.2 V | | 0.25 | | | | |
| | | I _{OL} = 6 mA | | 1.4 V | 1.4 V | | | | | 0.35 | V |
| V _{OL} | | I _{OL} = 8 mA | $V_{I} = V_{IL}$ | 1.65 V | 1.65 V | | | | | 0.45 | v |
| | | I _{OL} = 9 mA | | 2.3 V | 2.3 V | | | | | 0.55 | |
| | | I _{OL} = 12 mA | | 3 V | 3 V | | | | | 0.7 | |
| I | Control inputs | $V_I = V_{CCA}$ or GND | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | ±0.025 | ±0.25 | | ±1 | μA |
| | A an D mant | | \ <i>\</i> | 0 V | 0 V to 3.6 V | | ±0.1 | ±1 | | ±5 | |
| I _{off} | А ОГ В РОП | $V_1 \text{ or } V_0 = 0 \text{ to } 3.6$ | v | 0 V to 3.6 V | 0 V | | ±0.1 | ±1 | | ±5 | μA |
| I _{OZ} | A or B port | $V_{O} = V_{CCO} \text{ or GND}$ $V_{I} = V_{CCI} \text{ or GND},$ | <u>),</u> OE = V _{IH} | 3.6 V | 3.6 V | | ±0.5 | ±2.5 | | ±5 | μA |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 8 | |
| I _{CCA} | | $V_I = V_{CCI} \text{ or } GND,$ | l _O = 0 | 0 V | 0 V to 3.6 V | | | | | -2 | μA |
| | | | | 0 V to 3.6 V | 0 V | | | | | 8 | |
| | | | | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 8 | |
| I _{CCB} | | $V_I = V_{CCI}$ or GND, | l _O = 0 | 0 V | 0 V to 3.6 V | | | | | 8 | μA |
| | | | | 0 V to 3.6 V | 0 V | | | | | -2 | |
| I _{CCA} + | I _{CCB} | $V_I = V_{CCI} \text{ or } GND,$ | l _O = 0 | 1.2 V to 3.6 V | 1.2 V to 3.6 V | | | | | 16 | μA |
| Ci | Control inputs | $V_{I} = 3.3 \text{ V or GND}$ | | 3.3 V | 3.3 V | | 3.5 | | | 4.5 | pF |
| Cio | A or B port | $V_0 = 3.3 \text{ V or GNE}$ |) | 3.3 V | 3.3 V | | 6 | | | 7 | pF |

 $\begin{array}{ll} \mbox{(1)} & V_{CCO} \mbox{ is the } V_{CC} \mbox{ associated with the output port.} \\ \mbox{(2)} & V_{CCI} \mbox{ is the } V_{CC} \mbox{ associated with the input port.} \end{array}$



SCES692-JUNE 2008

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 1.2 \text{ V}$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = 1.5 V ± 0.1 V | V _{CCB} = 1.8 V ± 0.15 V | V _{CCB} = 2.5 V ± 0.2 V | V _{CCB} = 3.3 V ± 0.3 V | UNIT | | |
|------------------|-----------------|----------------|--------------------------|-------------------------------------|--------------------------------------|-------------------------------------|-------------------------------------|------|-----|----|
| | | (001101) | TYP | TYP | TYP | TYP | ТҮР | | | |
| t _{PLH} | А | В | 2.5 | 2.1 | 1.9 | 1.9 | 1.9 | ~~~ | | |
| t _{PHL} | A | В | 2.5 | 2.1 | 1.9 | 1.9 | 1.9 | ns | | |
| t _{PLH} | В | А | 2.5 | 2.2 | 2 | 1.8 | 1.7 | ~~~ | | |
| t _{PHL} | Б | A | 2.5 | 2.2 | 2 | 1.8 | 1.7 | ns | | |
| t _{PZH} | OE | • | 3.8 | 3.1 | 2.7 | 2.6 | 3 | | | |
| t _{PZL} | ÛE | A | 3.8 | 3.1 | 2.7 | 2.6 | 3 | ns | | |
| t _{PZH} | OE | В | 3.7 | 3.7 | 3.7 | 3.7 | 3.7 | ~~~ | | |
| t _{PZL} | ÛE | В | 3.7 | 3.7 | 3.7 | 3.7 | 3.7 | ns | | |
| t _{PHZ} | OE | ٨ | 4.4 | 3.6 | 3.5 | 3.3 | 4.1 | ~~~ | | |
| t _{PLZ} | 0E | A | 4.4 | 3.6 | 3.5 | 3.3 | 4.1 | ns | | |
| t _{PHZ} | | В | 4.2 | 4.2 | 4.3 | 4.1 | 4.2 | | | |
| t _{PLZ} | OE | OE | OE | В | 4.2 | 4.2 | 4.3 | 4.1 | 4.2 | ns |

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT |
|------------------|-----------------|----------------|--------------------------|-----------------------------|-----|-----------------------------|-----|-----------------------------|-----|-------------------------------------|-----|------|
| | (INFUT) | (001201) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | В | 2.2 | 0.3 | 4.4 | 0.2 | 3.9 | 0.1 | 3.6 | 0.1 | 3.9 | 20 |
| t _{PHL} | A | Б | 2.2 | 0.3 | 4.4 | 0.2 | 3.9 | 0.1 | 3.6 | 0.1 | 3.9 | ns |
| t _{PLH} | В | А | 2 | 0.6 | 5.1 | 0.4 | 4.9 | 0.2 | 4.6 | 0.1 | 4.5 | 20 |
| t _{PHL} | Б | A | 2 | 0.6 | 5.1 | 0.4 | 4.9 | 0.2 | 4.6 | 0.1 | 4.5 | ns |
| t _{PZH} | OE | А | 3.4 | 1.1 | 7.1 | 0.9 | 6.2 | 0.7 | 5.5 | 0.1 | 6.4 | 20 |
| t _{PZL} | ÛE | A | 3.4 | 1.1 | 7.1 | 0.9 | 6.2 | 0.7 | 5.5 | 0.1 | 6.4 | ns |
| t _{PZH} | OE | В | 2.5 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | 20 |
| t _{PZL} | ÛE | Б | 2.5 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | 1.1 | 8.2 | ns |
| t _{PHZ} | OE | А | 4.1 | 1.2 | 7.1 | 0.8 | 6.7 | 0.4 | 5.6 | 1 | 74 | 20 |
| t _{PLZ} | UE | A | 4.1 | 1.2 | 7.1 | 0.8 | 6.7 | 0.4 | 5.6 | 1 | 7.4 | ns |
| t _{PHZ} | OE | В | 3.3 | 0.3 | 7.4 | 0.2 | 5.7 | 0.3 | 5.6 | 0.3 | 5.6 | 20 |
| t _{PLZ} | UE | В | 3.3 | 0.3 | 7.4 | 0.2 | 5.7 | 0.3 | 5.6 | 0.3 | 5.6 | ns |



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SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT | |
|------------------|-----------------|----------------|--------------------------|-----------------------------|-----|--------------------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|------|----|
| | (INPUT) | (001P01) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | |
| t _{PLH} | А | В | 2 | 0.1 | 4.1 | 0.1 | 3.6 | 0.1 | 3.1 | 0.1 | 3.3 | | |
| t _{PHL} | A | D | 2 | 0.1 | 4.1 | 0.1 | 3.6 | 0.1 | 3.1 | 0.1 | 3.3 | ns | |
| t _{PLH} | В | А | 1.9 | 0.4 | 4.3 | 0.1 | 4.1 | 0.1 | 3.8 | 0.1 | 3.7 | ns | |
| t _{PHL} | D | A | 1.9 | 0.4 | 4.3 | 0.1 | 4.1 | 0.1 | 3.8 | 0.1 | 3.7 | 115 | |
| t _{PZH} | OE | ^ | 3.2 | 0.8 | 6.7 | 0.4 | 5.8 | 0.4 | 4.8 | 0.3 | 4.6 | 20 | |
| t _{PZL} | 0E | A | 3.2 | 0.8 | 6.7 | 0.4 | 5.8 | 0.4 | 4.8 | 0.3 | 4.6 | ns | |
| t _{PZH} | OE | В | 1.9 | 0.2 | 6.7 | 0.2 | 6.6 | 0.2 | 6.7 | 0.2 | 6.7 | 20 | |
| t _{PZL} | 0E | Б | 1.9 | 0.2 | 6.7 | 0.2 | 6.6 | 0.2 | 6.7 | 0.2 | 6.7 | ns | |
| t _{PHZ} | OE | А | 3.8 | 0.7 | 6.2 | 0.3 | 6.5 | 0.1 | 5.2 | 0.8 | 6.5 | ns | |
| t _{PLZ} | UE | A | 3.8 | 0.7 | 6.2 | 0.3 | 6.5 | 0.1 | 5.2 | 0.8 | 6.5 | 115 | |
| t _{PHZ} | | Р | 3.4 | 0.1 | 6.8 | 0.1 | 6.8 | 0.1 | 6.7 | 0.1 | 6.7 | 20 | |
| t _{PLZ} | OE | В | OE B — | 3.4 | 0.1 | 6.8 | 0.1 | 6.8 | 0.1 | 6.7 | 0.1 | 6.7 | ns |

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|-----------------|----------------|--------------------------|-----------------------------|-----|-----------------------------|-----|-----------------------------|-----|-----------------------------|-----|------|
| | (INFUT) | (001201) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | В | 1.9 | 0.1 | 3.8 | 0.1 | 3.2 | 0.1 | 2.7 | 0.1 | 2.6 | 5 |
| t _{PHL} | A | Б | 1.9 | 0.1 | 3.8 | 0.1 | 3.2 | 0.1 | 2.7 | 0.1 | 2.6 | ns |
| t _{PLH} | В | А | 1.8 | 0.5 | 3.4 | 0.2 | 3.1 | 0.1 | 2.8 | 0.1 | 2.6 | 20 |
| t _{PHL} | D | A | 1.8 | 0.5 | 3.4 | 0.2 | 3.1 | 0.1 | 2.8 | 0.1 | 2.6 | ns |
| t _{PZH} | OE | А | 3.1 | 0.7 | 6.2 | 0.5 | 5.2 | 0.3 | 4.1 | 0.3 | 3.6 | 5 |
| t _{PZL} | UE | A | 3.1 | 0.7 | 6.2 | 0.5 | 5.2 | 0.3 | 4.1 | 0.3 | 3.6 | ns |
| t _{PZH} | OE | В | 1.4 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | 20 |
| t _{PZL} | UE | Б | 1.4 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | 0.4 | 4.5 | ns |
| t _{PHZ} | ŌĒ | А | 3.6 | 0.2 | 5.2 | 0.1 | 5.4 | 0.1 | 4.5 | 0.7 | 6 | 20 |
| t _{PLZ} | UE | A | 3.6 | 0.2 | 5.2 | 0.1 | 5.4 | 0.1 | 4.5 | 0.7 | 6 | ns |
| t _{PHZ} | OE | В | 2.1 | 0.1 | 4.7 | 0.1 | 4.6 | 0.1 | 4.7 | 0.1 | 4.7 | 20 |
| t _{PLZ} | UE | В | 2.1 | 0.1 | 4.7 | 0.1 | 4.6 | 0.1 | 4.7 | 0.1 | 4.7 | ns |



SCES692-JUNE 2008

SWITCHING CHARACTERISTICS

over recommended operating free-air temperature range, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.2 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT | | | |
|------------------|-----------------|----------------|--------------------------|-----------------------------|-----|-----------------------------|-----|-----------------------------|-----|-----------------------------|-----|------|-----|-----|----|
| | (INFUT) | (001201) | TYP | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | | | | |
| t _{PLH} | А | В | 1.8 | 0.1 | 3.6 | 0.1 | 3 | 0.1 | 2.6 | 0.1 | 2.4 | 20 | | | |
| t _{PHL} | A | D | 1.8 | 0.1 | 3.6 | 0.1 | 3 | 0.1 | 2.6 | 0.1 | 2.4 | ns | | | |
| t _{PLH} | В | А | 1.9 | 0.5 | 3.4 | 0.2 | 2.9 | 0.1 | 2.5 | 0.1 | 2.3 | 20 | | | |
| t _{PHL} | Б | A | 1.9 | 0.5 | 3.4 | 0.2 | 2.9 | 0.1 | 2.5 | 0.1 | 2.3 | ns | | | |
| t _{PZH} | OE | А | 3.1 | 0.9 | 5.9 | 0.5 | 5 | 0.3 | 3.8 | 0.3 | 3.3 | 20 | | | |
| t _{PZL} | ÛE | A | 3.1 | 0.9 | 5.9 | 0.5 | 5 | 0.3 | 3.8 | 0.3 | 3.3 | ns | | | |
| t _{PZH} | OE | В | 1.2 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | 20 | | | |
| t _{PZL} | ÛE | D | 1.2 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | 0.4 | 3.6 | ns | | | |
| t _{PHZ} | OE | • | 3.4 | 0.1 | 4.6 | 0.1 | 4.7 | 0.3 | 4.8 | 0.7 | 4.5 | 20 | | | |
| t _{PLZ} | UE | A | 3.4 | 0.1 | 4.6 | 0.1 | 4.7 | 0.3 | 4.8 | 0.7 | 4.5 | ns | | | |
| t _{PHZ} | | Р | 2.9 | 0.1 | 5.4 | 0.1 | 5.3 | 0.1 | 5.3 | 0.1 | 5.3 | | | | |
| t _{PLZ} | ŌE | В — | В | В | В | 2.9 | 0.1 | 5.4 | 0.1 | 5.3 | 0.1 | 5.3 | 0.1 | 5.3 | ns |

OPERATING CHARACTERISTICS

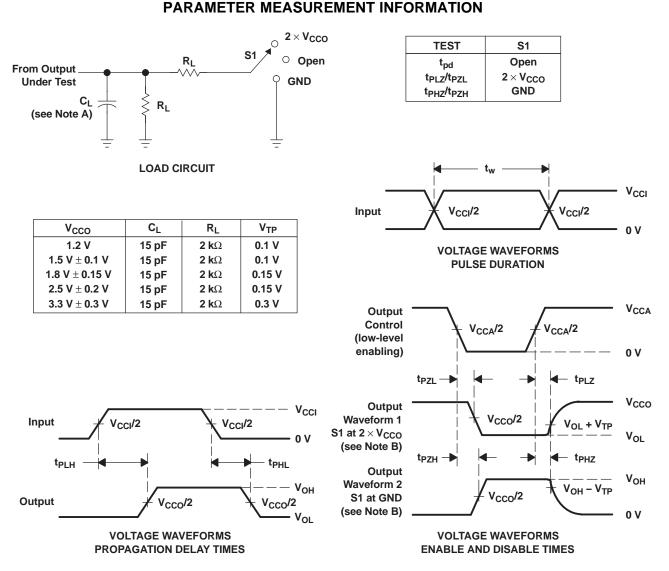
 $T_A = 25^{\circ}C$

| F | PARAME | TER | TEST CONDITIONS | V _{CCA} = V _{CCB} = 1.2 V TYP | V _{CCA} = V _{CCB} = 1.5 V TYP | V _{CCA} = V _{CCB} = 1.8 V TYP | V _{CCA} = V _{CCB} = 2.5 V TYP | V _{CCA} = V _{CCB} = 3.3 V TYP | UNIT |
|---------------------------------|-------------------------------|------------------|--|---|---|---|---|---|------|
| | A to D | Outputs enabled | | 3 | 3 | 3 | 3 | 4 | |
| C _{pdA} ⁽¹⁾ | A to B | Outputs disabled | $C_{L} = 0,$ | 1 | 1 | 1 | 2 | 2 | ۶E |
| CpdA | B to A | Outputs enabled | f = 10 MHz, $t_r = t_f = 1 \text{ ns}$ | 12 | 13 | 13 | 15 | 15 | pF |
| | D IU A | Outputs disabled | | 1 | 2 | 2 | 2 | 2 | |
| | A to D | Outputs enabled | | 12 | 13 | 13 | 14 | 16 | |
| C _{pdB} ⁽¹⁾ | A to B | Outputs disabled | $C_L = 0,$ | 1 | 2 | 2 | 2 | 2 | ~ - |
| ⊂pdB`´ | P to A | Outputs enabled | f = 10 MHz, $t_r = t_f = 1 \text{ ns}$ | 3 | 3 | 3 | 4 | 4 | pF |
| | B to A Outputs disabled | | 1 | 1 | 1 | 2 | 2 | | |

(1) Power dissipation capacitance per transceiver



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \le 10$ MHz, $Z_0 = 50 \Omega$, $dv/dt \ge 1$ V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

Figure 2. Load and Circuit and Voltage Waveforms



PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|--------------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| SN74AVC2T245RSWR | ACTIVE | UQFN | RSW | 10 | 3000 | Green (RoHS & no Sb/Br) | NIPDAU | Level-1-260C-UNLIM | Request Free Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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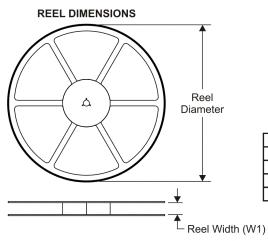
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 180.0 | 8.4 | 1.59 | 2.09 | 0.72 | 4.0 | 8.0 | Q1 |

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

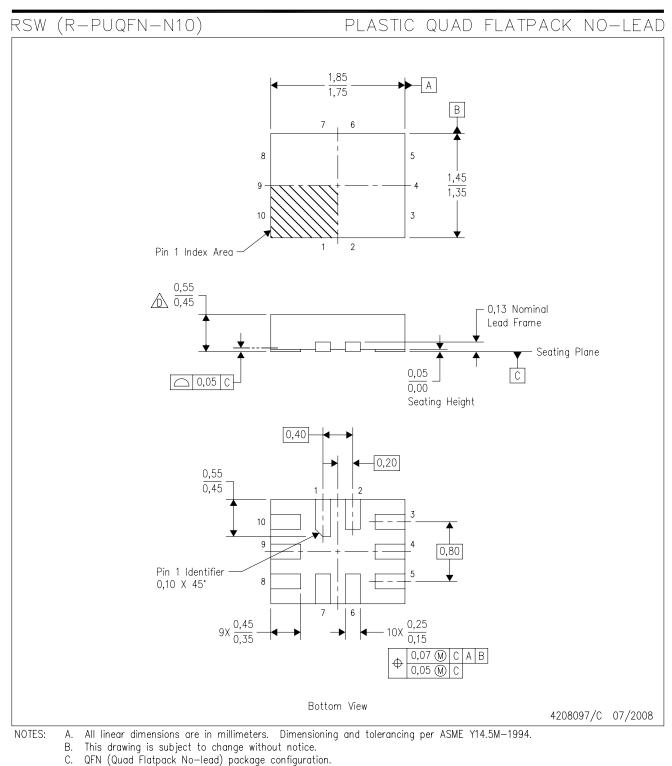
31-Jul-2010



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AVC2T245RSWR | UQFN | RSW | 10 | 3000 | 202.0 | 201.0 | 28.0 |

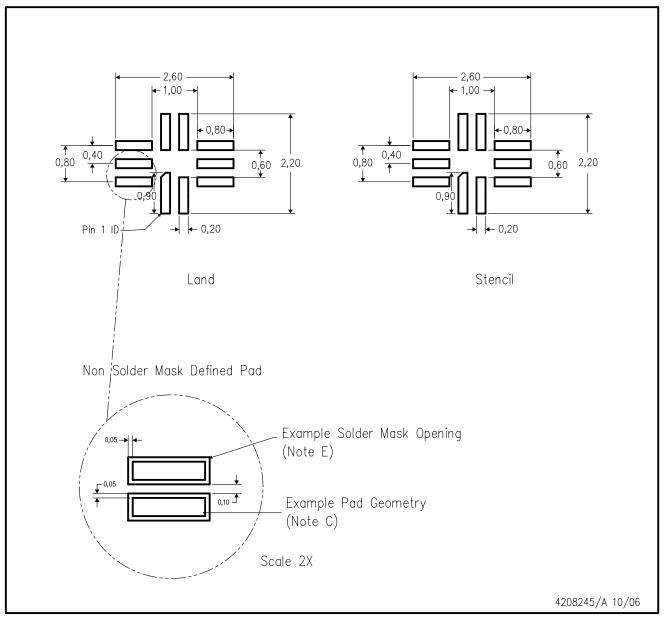
MECHANICAL DATA



This package complies to JEDEC MO-288 variation UDEE, except minimum package height.



RSW (R-PQFP-N10)



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Publication IPC-7351 is recommended for alternate designs.

D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.

E. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.



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